

## 1N4306 • 1N4307

### PAIR AND QUAD ASSEMBLIES DIODES OF SILICON PLANAR EPITAXIAL

- $\Delta V_f$  ... 10 mV (MAX)
- C ... 2.0 pF (MAX)

#### GENERAL DESCRIPTION

The 1N4306 and 1N4307 are epoxy encapsulated assemblies of two and four glass diodes respectively. They feature tightly matched forward voltages over broad current and temperature ranges.

#### ABSOLUTE MAXIMUM RATINGS (Note 1)

##### Temperatures

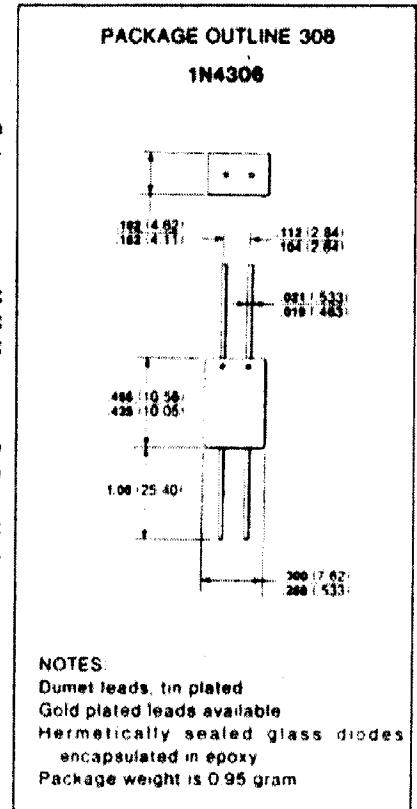
Storage Temperature Range	-65°C to +150°C
Maximum Junction Operating Temperature	+150°C
Lead Temperature	+260°C

##### Power Dissipation (Note 2)

Maximum Total Power Dissipation at 25°C Ambient	
Each Diode	250 mW
Encapsulated Package	500 mW
Linear Derating Factor (from 25°C)	
Each Diode	2.0 mW/°C
Encapsulated Package	4.0 mW/°C

##### Maximum Voltage and Currents

WIV	Working Inverse Voltage	50 V
IO	Average Rectified Current	200 mA
IF	Continuous Forward Current	300 mA
IF	Recurrent Peak Forward Current	600 mA
IF(surge)	Peak Forward Surge Current	
	Pulse Width = 1.0 s	1.0 A
	Pulse Width = 1.0 $\mu$ s	4.0 A



#### ELECTRICAL CHARACTERISTICS (25°C Ambient Temperature unless otherwise noted)

SYMBOL	CHARACTERISTIC	MIN	MAX	UNITS	TEST CONDITIONS
BV	Breakdown Voltage	75		V	$I_R = 5.0$ mA
$I_R$	Reverse Current		50	nA	$V_R = 50$ V
			50	nA	$V_R = 50$ V, $T_A = 150^\circ\text{C}$
$V_F$	Forward Voltage	0.75	1.00	V	$I_F = 50$ mA
		0.67	0.81	V	$I_F = 10$ mA
		0.66	0.67	V	$I_F = 1.0$ mA
		0.44	0.55	V	$I_F = 100$ $\mu$ A
C	Capacitance		2.0	pF	$V_R = 0$ , $f = 1$ MHz
$t_{rr}$	Reverse Recovery Time		4.0	ns	$I_F = I_R = 10$ mA, $R_L = 100\Omega$ Recovery to 1 mA
$\Delta V_F$	Forward Voltage Match (Note 4)		10	mV	$I_F = 0.1$ to 10 mA $T_A = -55^\circ\text{C}$ to $+125^\circ\text{C}$
			20	mV	$I_F = 10$ to 50 mA $T_A = -55^\circ\text{C}$ to $+125^\circ\text{C}$

#### NOTES:

1. These are limiting values above which life or satisfactory performance may be impaired.
2. These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operation.
3. For product family characteristic curves, refer to Chapter 4, D4.
4. For test circuits, refer to Chapter 4, D18.